

TECHNICAL DATA SHEET



DIC PSAs
web page

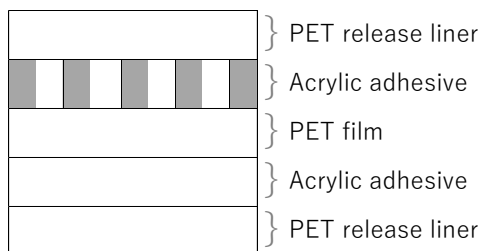


1H91A3 E Color & Comfort

Very thin double coated adhesive tape

DAITAC® TN10AIR

■ Construction



※Outside of a roll

■ Characteristics

- ✓ Tape thickness is 10 μ m.
- ✓ Good die-cutting workability
- ✓ Good workability.
- ✓ Air release technology to help prevent air entrapment during lamination.
- ✓ Product does not use the 6 restrictive substances of the RoHS Directive.

■ Applications

- ✓ Excellent air bubble prevention when laminating large areas.
- ✓ For bonding to large areas.

■ Properties

Test item	Condition	Substrate	Unit	TN10AIR	
				Flat side	Emboss side
Thickness	Except release liner	-	μ m	10	
180 deg. peel strength	23°C, 1hr	SUS (hairline)	N/20mm	3	5
Air Releasing	-	-	-	-	Excellent

■ Size 1,000mm in max width 100-150m in length

DIC Corp.

Composite Materials Product Div.

https://www.dic-global.com/en/products/adhesive_tapes

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